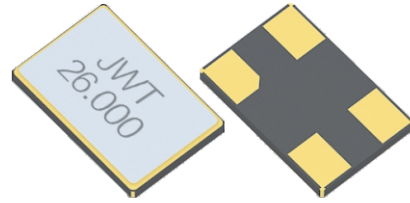


■特点 Features

标准的 2.0 x 1.6 x 0.50mm 陶瓷封装表面贴装形式
 小公差及高稳定性
 适应自动装配的8MM宽度的编带包装
 包装：每卷1000/2000/3000PCS

Typical 2.0 x 1.6 x 0.50 mm Ceramic SMD package
 Tight tolerance and Stability
 8mm width Tape&Reel package for automatic assembly
 Packing: Tape & Reel, 1000/2000/3000 pcs per Reel



■标准规格 Electronic Specification

型号 Type	SMD2016
频率范围 Frequency Range	16.000 ~ 54.000MHz
振荡模式 Oscillator Mode	Fundamental(AT cut) 基频(AT切)
调整频差 Frequency Tolerance(at25°C)	±10ppm, ±20ppm, ±30ppm
温度频差 Frequency Stability	具体见表2
工作温度 Operating Temperature Range	-40°C ~ 125°C
贮存温度 Storage Temperature Range	-55°C ~ 125°C
负载电容 Load Capacitance	Custom design
激励电平 Drive Level	10μW Typical (100μW max)
静态电容 Shunt Capacitance	5pF max.
老化率 Aging	ΔF/F:±3PPM/year(max)

■等效电阻 Equivalent Series Resistance(E.S.R.)

频率范围 Frequency Range	盒型 Hold Type	振动模式 Mode	等效电阻 E.S.R.	频率范围 Frequency Range	盒型 Hold Type	振动模式 Mode	等效电阻 E.S.R.
16.000 ~ 19.999MHz	SMD	AT,Fund	150ΩMax	30.000 ~ 54.000MHz	SMD	AT,Fund	80ΩMax.
20.000 ~ 29.999MHz	SMD	AT,Fund	100ΩMax				

Table 1

■温度频差和工作温度范围 Frequency Stability Vs Operating Temperature range

Temp.(°C)\ppm	±5	±10	±15	±20	±25	±30	±50
-10 to 60°C	△	○	○	○	○	○	○
-20 to 70°C		△	○	○	○	○	○
-40 to 85°C				△	○	○	○
-40 to 125°C						△	○

○:可实现的 △:与供应商沟通

Table 2

■外型尺寸 Outline Dimensions(Unit:mm)

